



Low ON-Resistance, Low Voltage, SPDT Analog Switch

FEATURES

• -3dB Bandwidth: 120MHz

High Speed, Typically 29ns

Supply Range: +1.8V to +5.5V

Low ON-State Resistance, 3.0Ω(TYP)

• Break-Before-Make Switching

• Rail-to-Rail Operation

• TTL/CMOS Compatible

MicroSIZE PACKAGE: SOT363(SC70-6)

Extended Industrial Temperature

Range: -40°C to +125°C

APPLICATIONS

- Wearable Devices
- Battery-Operated Equipment
- Signal Gating, Chopping, Modulation or Demodulation (Modem)
- Portable Computing
- Cell Phones

FUNCTION TABLE

LOGIC	NO	NC
0	OFF	ON
1	ON	OFF

PIN DESCRIPTION

NAME	PIN	FUNCTION
IN	1	Digital Control Pin
V+	2	Power Supply
GND	3	Ground
NC	4	Normally-Closed Terminal
COM	5	Common Terminal
NO	6	Normally-Open Terminal

DESCRIPTION

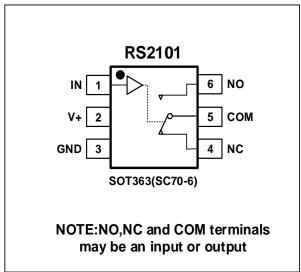
The RS2101 is a low on-resistance, single-pole double-throw (SPDT) analog switch that is designed to operate from 1.8 V to 5.5 V.

The RS2101 device can handle both analog and digital signals. It features fast switching speeds (ton = 29ns, toff = 17ns) and low on-resistance (3.0 Ω TYP).

These features make this device suitable for a wide variety of portable applications including cell phones, audio devices, and instrumentation.

Applications include signal gating, chopping, modulation or demodulation (modem), and signal multiplexing for analog-to-digital and digital-to-analog conversion systems.

PIN CONFIGURATIONS





SPECIFICATIONS

Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted) (1)

SYMBOL	PARAMETER	MIN	MAX	UNIT	
V ₊	Supply Voltage	-0.3	6.0		
VIN	Input Voltage ⁽²⁾	-0.3	6.0	V	
	Analog, Digital Voltage Range	-0.3	(V ₊)+0.3		
	Continuous Current NO, NC, or COM	-300	+300	A	
I _{PEAK}	Peak Current NO, NC, or COM	-500	+500	mA	
TJ	Junction Temperature		150	°C	
T _{stg}	Storage temperature	-65	+150		

⁽¹⁾ Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

ESD Ratings

			VALUE	UNIT
\/	Electrostatic discharge	Human-body model (HBM)	±3000	V
V(ESD)	Liectiostatic discharge	Machine Model (MM)	±200	V

Recommended Operating Conditions

Over operating free-air temperature range (unless otherwise noted) (3)

SYMBOL	PARAMETER	MIN	MAX	UNIT
Vcc	Supply Voltage	1.8	5.5	V
TA	Operating temperature	-40	+125	°C

Thermal Information

THERMAL METRIC		RS2101	
		6 PINS	UNIT
		SOT363(SC70-6)	
R _{ΘJA} Junction-to-ambient thermal resistance		250	°C/W

⁽²⁾ Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.3V beyond the supply rails should be current-limited to 10mA or less.



PACKAGE/ORDERING INFORMATION

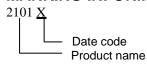
PRODUCT	ORDERING NUMBER	TEMPERATURE RANGE	PACKAGE LEAD	PACKAGE MARKING ^(1/2)	PACKAGE OPTION
RS2101	RS2101XC6	-40°C~125°C	SOT363 (SC70-6)	2101 <u>X</u>	Tape and Reel,3000

NOTE:

(1) There may be additional marking, which relates to the lot trace code information(data code and vendor code), the logo or the environmental category on the device.

(2) \underline{X} = Date Code

MARKING INFORMATION





ELECTRICAL CHARACTERISTICS

 $V+ = 5.0 \text{ V}, T_A = -40^{\circ}\text{C} \text{ to } 125^{\circ}\text{C} \text{ (unless otherwise noted)}$

PARAMETER	SYMBOL	CONDITIONS	V+	TA	MIN	TYP	MAX	UNITS
ANALOG SWITCH								
Analog Signal Range	Vno, Vnc, Vcom			FULL	0		V+	V
			5V	+25°C		3.0	4.0	Ω
On-Resistance	Ron	$0 \le (V_{NO} \text{ or } V_{NC}) \le V_{+},$	ον	FULL			5.0	Ω
On-Resistance	KON	I _{COM} = -10mA, Switch ON, See Figure 1	3.3V	+25°C		5.5	7.0	Ω
			3.31	FULL			7.5	Ω
			5V	+25°C		0.1	0.8	Ω
On-Resistance Match	۸n	$0 \le (V_{NO} \text{ or } V_{NC}) \le V_{+},$	ον	FULL			0.9	Ω
Between Channels	$\Delta R_{ m ON}$	I _{COM} = -10mA, Switch ON, See Figure 1	3.3V	+25°C		0.1	8.0	Ω
			3.31	FULL			0.9	Ω
	Rflat(on)	$0 \leqslant (V_{NO} \text{ or } V_{NC}) \leqslant V+,$ I_{COM} = -10mA, Switch ON, See Figure 1	<i>5</i> \/	+25°C		0.7	0.85	Ω
On Besistanes Flatness			5V	FULL			0.95	Ω
On-Resistance Flatness			3.3V	+25°C		2.5	3.0	Ω
				FULL			3.2	Ω
NC,NO OFF Leakage Current	Inc(off), Ino(off)	V _{NO} or V _{NC} = 0.3V, V+/2 V _{COM} = V+/2, 0.3V See Figure 2	1.8 to 5.5V	FULL			1	μΑ
NC,NO,COM ON Leakage Current	Inc(on), Ino(on), Icom(on)	V _{NO} or V _{NC} = 0.3V, Open V _{COM} = Open, 0.3V See Figure 2	1.8 to 5.5V	FULL			1	μΑ
DIGITAL CONTROL INP	UTS ⁽¹⁾		•	l.		I.	I.	
			5V	FULL	1.5			V
Input High Voltage	Vinh		3.3V	FULL	1.3			V
I 1 1/- 1/			5V	FULL			0.6	V
Input Low Voltage	VINL		3.3V	FULL			0.5	V
Input Leakage Current	lin	Vin = Vio or 0	1.8 to 5.5V	FULL			1	μA

⁽¹⁾ All unused digital inputs of the device must be held at Vio or GND to ensure proper device operation.



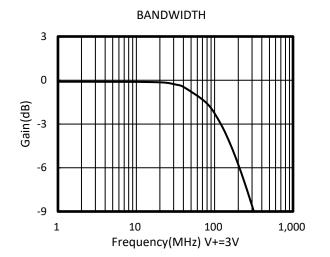
ELECTRICAL CHARACTERISTICS (continued) V+ = 5.0 V, TEMP= -40°C to 125°C (unless otherwise noted))

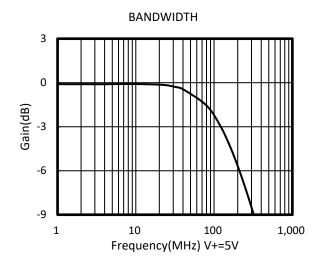
PARAMETER	SYMBOL	CONDITIONS		V+	TEMP	MIN	TYP	MAX	UNITS
DYNAMIC CHARACTER	RISTICS								
Turn On Time	4	$V_{COM} = V+, R_L = 300\Omega, C_L = 35pF,$		5V	.05%		29		20
Turn-On Time	ton	See Figure 5	•	3.3V	+25°C		33		ns
Turn-Off Time	toff	$V_{COM} = V+, R_L = 300\Omega,$, C _L = 35pF,	5V	+25°C		17		ns
Turr-On Time	torr	See Figure 5		3.3V	725 C		18		113
Break-Before-Make	tввм	$V_{NO1} = V_{NC1} = V_{NO2} = V$	$'_{NC2} = 3V$,	5V	+25°C		10		ns
Time Delay	IBBM	$R_L = 300\Omega$, $C_L = 35pF$,	$R_L = 300\Omega$, $C_L = 35pF$, See Figure 6		723 C		11		115
O# 11-4:	Oiso	$R_L = 50\Omega$, Switch OFF, See Figure 8	f = 10MHz		+25°C		-43		dB
Off Isolation			f = 1MHz		+25°C		-67		dB
-3dB Bandwidth	BW	Switch ON, $R_L = 50\Omega$ See Figure 7	· · · · · · · · · · · · · · · · · · ·		+25°C		120		MHz
NC,NO OFF Capacitance	CNC(OFF), CNO(OFF)	V _{NC} or V _{NO} =V+/2 or GN OFF See Figure 4	ND, Switch		+25°C		15		pF
NC,NO,COM ON Capacitance	CNC(ON), CNO(ON), CCOM(ON)				+25°C		50		pF
POWER REQUIREMENTS									
Power Supply Range	V+				FULL	1.8		5.5	V
Power Supply Current	l+	V _{IN} = GND or V ₊		5.5V	FULL			1	μΑ



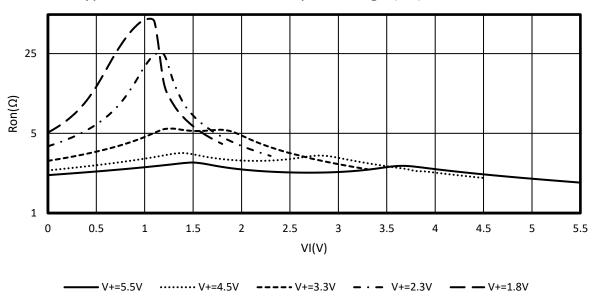
TYPICAL CHARACTERISTICS

 $V+ = 5.0 \text{ V}, T_A = -40^{\circ}\text{C} \text{ to } 125^{\circ}\text{C} \text{ (unless otherwise noted)}$





Typical ron as a Function of Input Voltage (VI) for VI = 0 to V+





Parameter Measurement Information

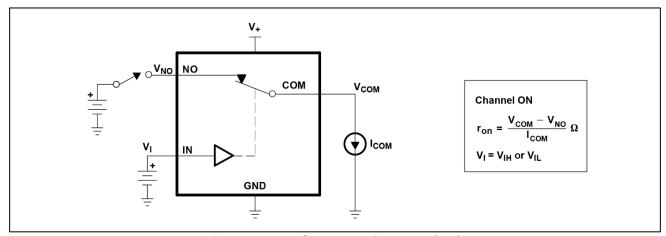


Figure 1.ON-State Resistance (ron)

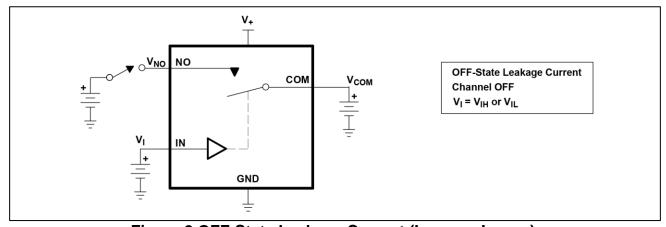


Figure 2.OFF-State Leakage Current (ICOM(OFF), INO(OFF))

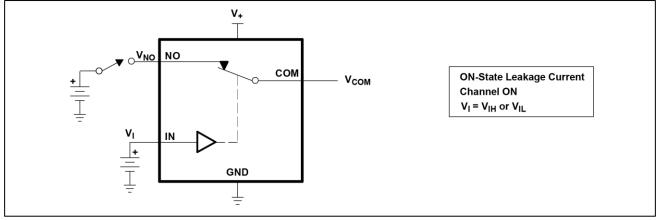


Figure 3.ON-State Leakage Current (ICOM(ON), INO(ON))



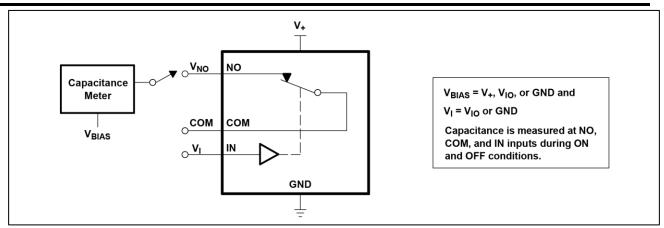


Figure 4. Capacitance (CI, CCOM(OFF), CCOM(ON), CNO(OFF), CNO(ON))

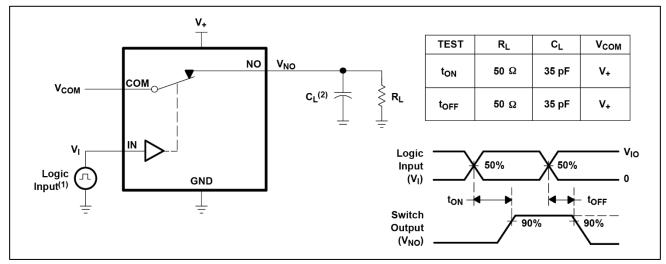


Figure 5.Turn-On (ton) and Turn-Off Time (toff)

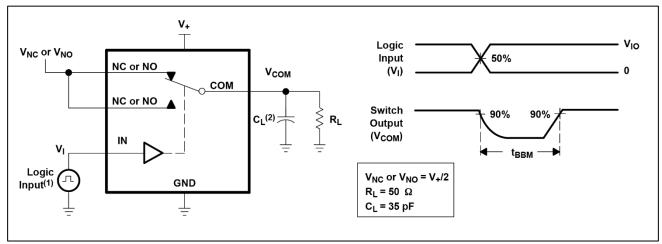


Figure 6.Break-Before-Make Time (tbbm)



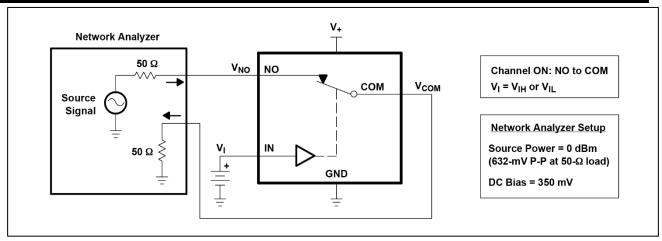


Figure 7.Bandwidth (BW)

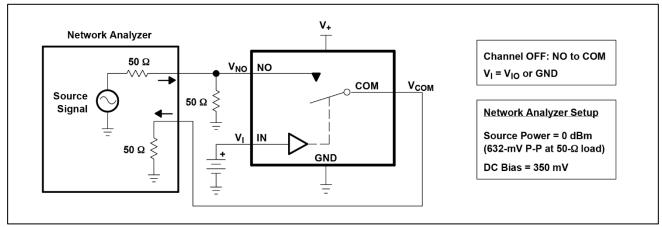


Figure 8.OFF Isolation (O_{ISO})

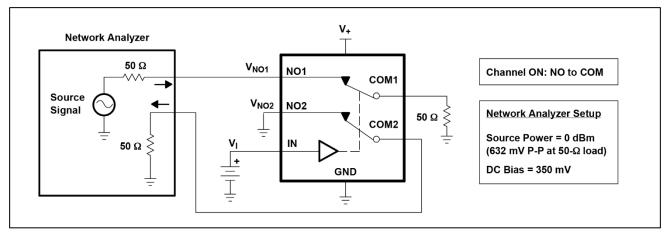


Figure 9.Crosstalk (XTALK)



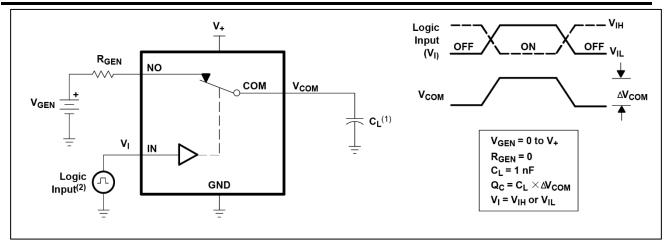


Figure 10.Charge Injection (Qc)

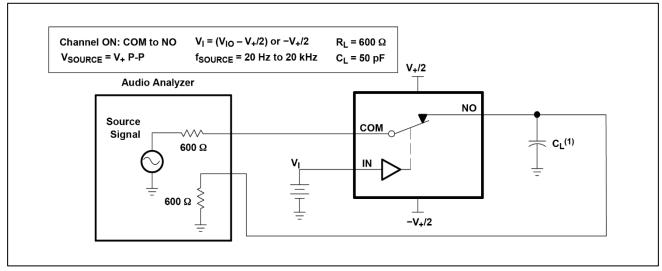
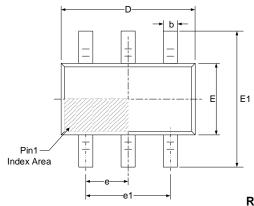
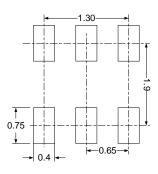


Figure 11. Total Harmonic Distortion (THD)

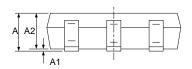


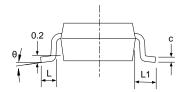
PACKAGE OUTLINE DIMENSIONS SOT363(SC70-6)





RECOMMENDED LAND PATTERN (Unit: mm)





Symbol	Dimensions I	n Millimeters	Dimension	s In Inches
Symbol	Min	Max	Min	Max
А	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
С	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
Е	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
е	0.650	(BSC)	0.026	(BSC)
e1	1.300	(BSC)	0.051	(BSC)
L	0.260	0.460	0.010	0.018
L1	0.5	525	0.0)21
θ	0°	8°	0° 8°	